# **XN04110** (XN4110)

# Silicon PNP epitaxial planar transistor

## For digital circuits/switching

#### ■ Features

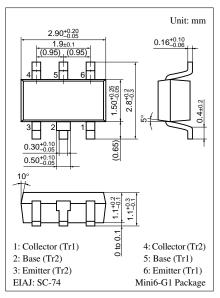
- Two elements incorporated into one package (Transistors with builtin resistor)
- Reduction of the mounting area and assembly cost by one half

### ■ Basic Part Number of Element

• UNR1110 (UN1110) × 2 elements

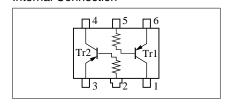
# ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit	
Rating	Collector to base voltage	$V_{CBO}$	-50	V	
of	Collector to emitter voltage	V <sub>CEO</sub>	-50	V	
element	Collector current	$I_C$	-100	mA	
Total	Total power dissipation	$P_{T}$	300	mW	
	Junction temperature	$T_{j}$	150	°C	
	Storage temperature	$T_{stg}$	-55 to +150	°C	



Marking Symbol: BI

### Internal Connection

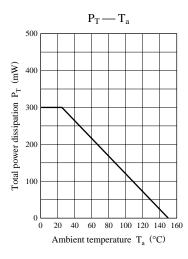


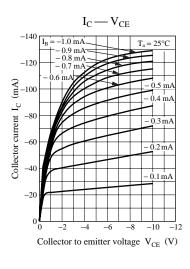
# ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

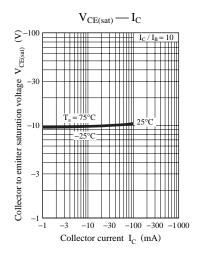
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector to base voltage	V <sub>CBO</sub>	$I_{\rm C} = -10 \; \mu \text{A}, \; I_{\rm E} = 0$	-50			V
Collector to emitter voltage	V <sub>CEO</sub>	$I_{\rm C} = -2 \text{ mA}, I_{\rm B} = 0$	-50			V
Collector cutoff current	$I_{CBO}$	$V_{CB} = -50 \text{ V}, I_E = 0$			- 0.1	μΑ
	I <sub>CEO</sub>	$V_{CE} = -50 \text{ V}, I_B = 0$			- 0.5	
Emitter cutoff current	$I_{EBO}$	$V_{EB} = -6 \text{ V}, I_C = 0$			- 0.01	mA
DC current gain	h <sub>FE</sub>	$V_{CE} = -10 \text{ V}, I_{C} = -5 \text{ mA}$	160		460	
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = -10 \text{ mA}, I_B = -0.3 \text{ mA}$			- 0.25	V
High level output voltage	V <sub>OH</sub>	$V_{CC} = -5 \text{ V}, V_{B} = -0.5 \text{ V}, R_{L} = 1 \text{ k}\Omega$	-4.9			V
Low level output voltage	V <sub>OL</sub>	$V_{CC} = -5 \text{ V}, V_B = -2.5 \text{ V}, R_L = 1 \text{ k}\Omega$			- 0.2	V
Input resistance	$R_1$		-30%	47	+30%	kΩ
Gain bandwidth product	$f_T$	$V_{CB} = -10 \text{ V}, I_E = 1 \text{ mA}, f = 200 \text{ MHz}$		80		MHz

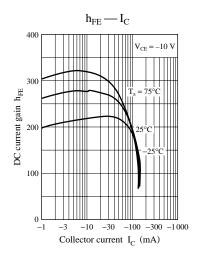
Note) The part number in the parenthesis shows conventional part number.

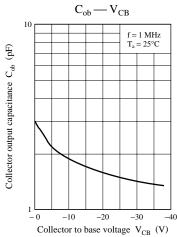
XN04110 Panasonic

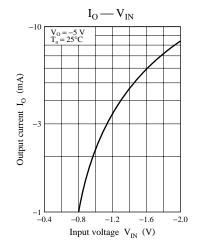


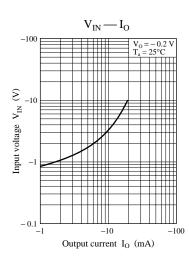












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